

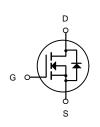
General Description

The DMT10H009SPS-13 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness.



DFN5X6-8L (Power(5x6))



N-Channel MOSFET

General Features

 $V_{DS} = 100V I_{D} = 75A$

 $R_{DS(ON)} < 7.5 m\Omega V_{GS} = 10 V$

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
DMT10H009SPS-13	DFN5X6-8L(Power(5x6))	HXY MOSFET	5000

Absolute Maximum Ratings at T_i=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	VDS	100	V
Gate source voltage	VGS	±20	V
Continuous drain current ¹⁾	ID	75	А
Pulsed drain current ²⁾	ID, pulse	300	А
Power dissipation ³⁾	P _D	97	W
Single pulsed avalanche energy ⁵⁾	EAS	90	mJ
Operation and storage temperature	Tstg,Tj	-55 to 150	°C
Thermal resistance, junction-case	RθJC	1.3	°C/W



Electrical Characteristics (T_J=25°C unless otherwise specified)

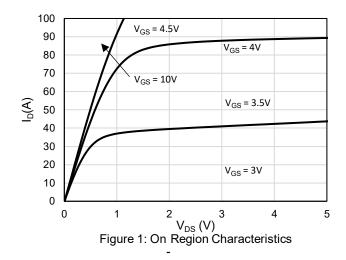
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
On Charac	cteristics			•		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	2.5	V
	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =20A	-	6.4	7.5	mΩ
$R_{DS(on)}$	note3	V _{GS} =4.5V, I _D =8A	-	9.2	11.4	mΩ
Dynamic (Characteristics					
C _{iss}	Input Capacitance		-	2944	-	pF
Coss	Output Capacitance	V _{DS} =50V, V _{GS} =0V,	-	736	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	2.04	-	pF
Qg	Total Gate Charge	V _{DS} =50V, I _D =30A,	-	39.4	-	nc
Q _{gs}	Gate-Source Charge		-	5.6	-	nc
Q_{gd}	Gate-Drain("Miller") Charge	- V _{GS} =10V	-	7.6	-	nc
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time		-	13	-	nc
t r	Turn-on Rise Time	V _{DD} =50V, I _D =25A,	_	27.5	-	nc
t _{d(off)}	Turn-off Delay Time	R _G =6Ω, V _{GS} =10V	-	45.5	-	nc
t _f	Turn-off Fall Time		-	41.5	-	nc
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	75	Α
I _{SM}		laximum Pulsed Drain to Source Diode Forward Current			300	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =30A	-	-	1	V
t _{rr}	Body Diode Reverse Recovery Time	T =25°C	-	177	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge	T _J =25°C, I _F =12A,dI/dt=100A/μs	-	1291	-	nc

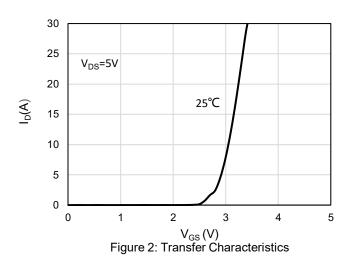
Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

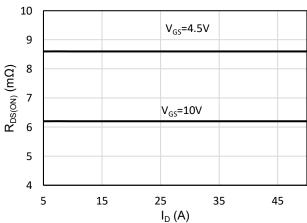
- 2. EAS condition: T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25 Ω , L=0.5mH, I_{AS} =19A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%

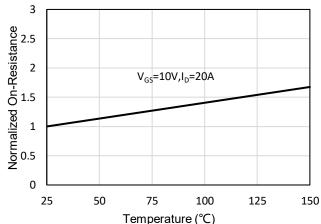


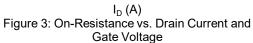
Typical Performance Characteristics

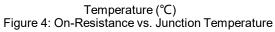


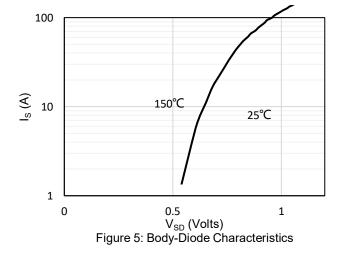


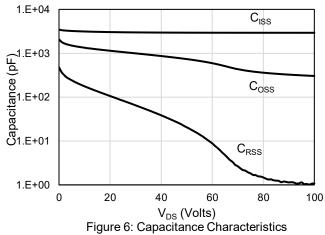




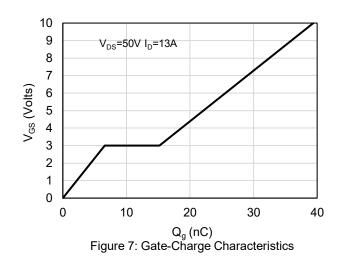


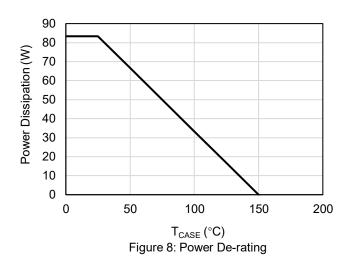


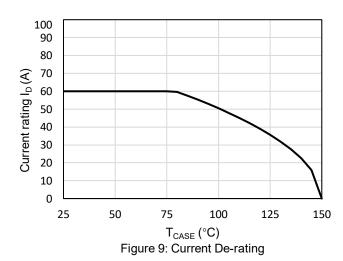


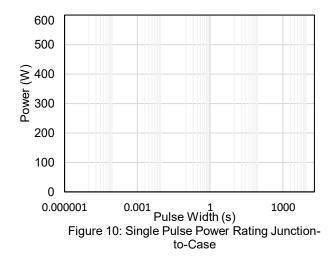


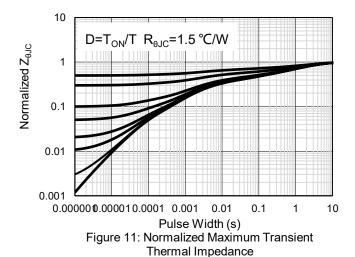












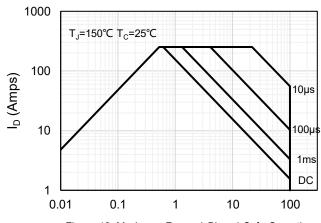
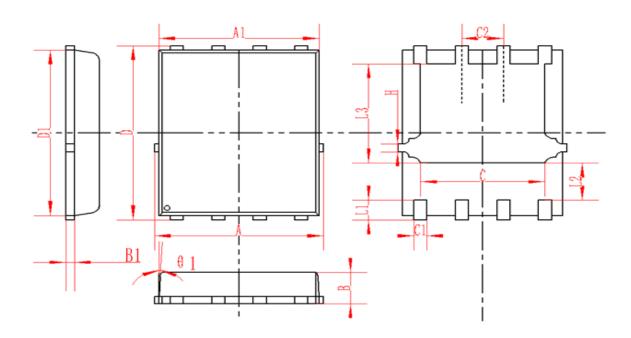


Figure 12: Maximum Forward Biased Safe Operating Area



DFN5X6-8L(Power(5x6)) Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Η	0.24	0.25	0.26	0.009	0.010	0.010



N-SGT Enhancement Mode MOSFET

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